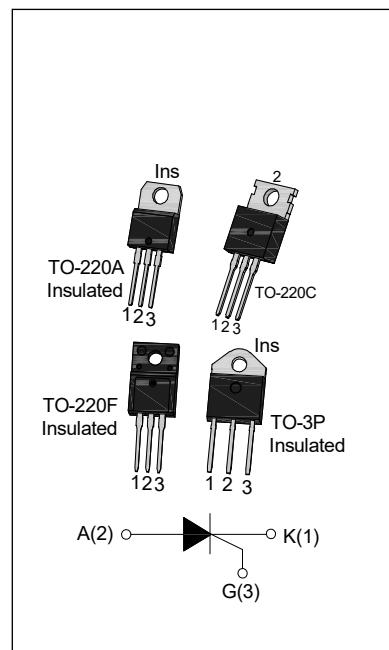


**DESCRIPTION:**

with high ability to withstand the shock loading of large current, JCT1230 SCRs provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc.

From all three terminals to external heatsink, JCT1230A & JCT1230Z provide a rated insulation voltage of 2500 V_{RMS}, and JCT1230F provides a rated insulation voltage of 2500 V_{RMS} complying with UL standards (File ref: E252906).

**MAIN FEATURES**

Symbol	JCT1230
V _{DRM} / V _{RRM}	1200V
I _{T(RMS)}	30A
I _{GT}	35mA

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Storage junction temperature range	T _{stg}	-40-150	°C
Operating junction temperature range	T _j	-40-125	°C
Repetitive peak off-state voltage	V _{DRM}	1200	V
Repetitive peak reverse voltage	V _{RRM}	1200	V
RMS on-state current	I _{T(RMS)}	30	A
	TO-3P (Ins) (T _c =90°C)		
	TO-220A(Ins)		
	TO-220F(Ins) (T _c =75°C)		
	TO-220C (T _c =85°C)		

Non repetitive surge peak on-state current (tp=10ms)	I _{TSM}	300	A
I ² t value for fusing (tp=10ms)	I ² t	450	A ² s
Critical rate of rise of on-state current (I _G =2×I _{GT})	dI/dt	150	A/μs
Peak gate current	I _{GM}	5	A
Peak gate power	P _{GM}	10	W
Average gate power dissipation (T _j =125°C)	P _{G(AV)}	1	W

ELECTRICAL CHARACTERISTICS (T_j=25°C unless otherwise specified)

Symbol	Test Condition	Value			Unit
		MIN.	TYP.	MAX.	
I _{GT}	V _D =12V R _L =30Ω	-	-	35	mA
V _{GT}		-	-	1.3	V
V _{GD}	V _D =V _{DRM} T _j =125°C	0.25	-	-	V
I _L	I _G =1.2 I _{GT}	-	-	100	mA
I _H	I _T =1A	-	-	80	mA
dV/dt	V _D =2/3V _{DRM} T _j =125°C Gate Open	500	-	-	V/μs

STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V _{TM}	I _{TM} =60A tp=380μs	T _c =25°C	1.7	V
I _{DRM}	V _D =V _{DRM} V _R =V _{RRM}	T _c =25°C	20	μA
I _{RRM}		T _c =125°C	6	mA

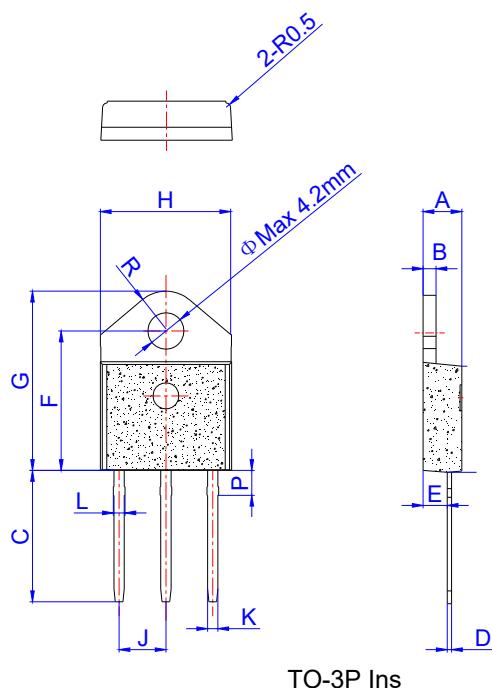
THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th(j-c)}	junction to case(DC)	TO-3P(Ins)	0.70
		TO-220B	0.85
		TO-220A(Ins)/ TO-220F(Ins)	1.12
			°C/W

ORDERING INFORMATION

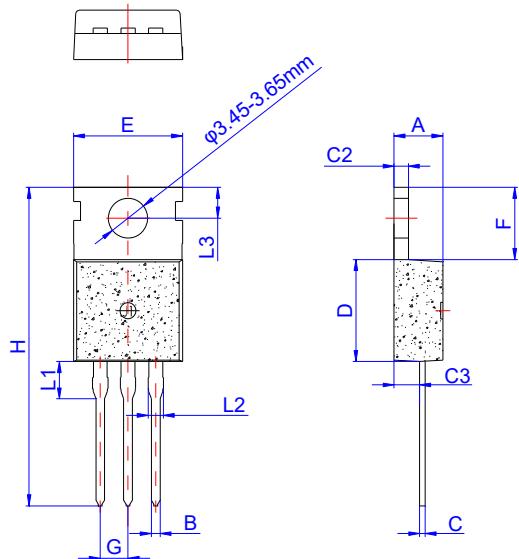
<u>J</u>	<u>CT</u>	<u>12</u>	<u>30</u>	<u>Z</u>
JieJie Microelectronics Co.,Ltd				C:TO-220C Z:TO-3P(Ins) A:TO-220A(Ins) F:TO-220F(Ins)
	SCRs			
		12:V _{DRM} /V _{RRM} ≥1200V		
			I _{T(RMS)} :30A	

PACKAGE MECHANICAL DATA



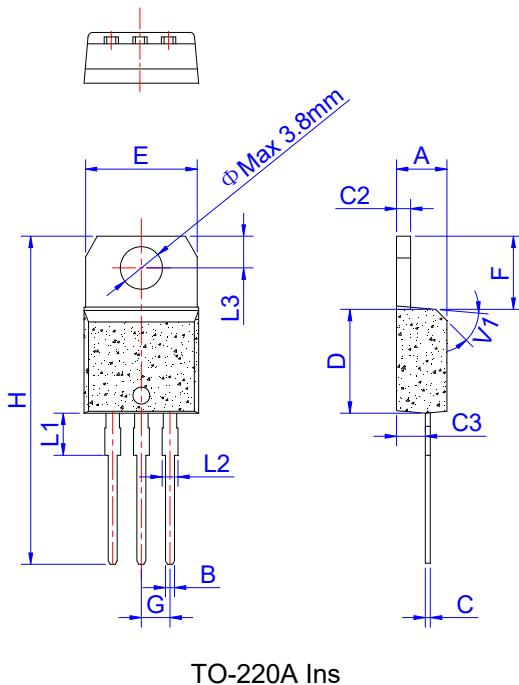
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	1.45		1.55	0.057		0.061
C	14.35		15.60	0.565		0.614
D	0.50		0.70	0.020		0.028
E	2.70		2.90	0.106		0.114
F	15.80		16.50	0.622		0.650
G	20.40		21.10	0.803		0.831
H	15.10		15.50	0.594		0.610
J	5.40		5.65	0.213		0.222
K	1.10		1.40	0.043		0.055
L	1.35		1.50	0.053		0.059
P	2.80		3.00	0.110		0.118
R		4.35			0.171	

PACKAGE MECHANICAL DATA

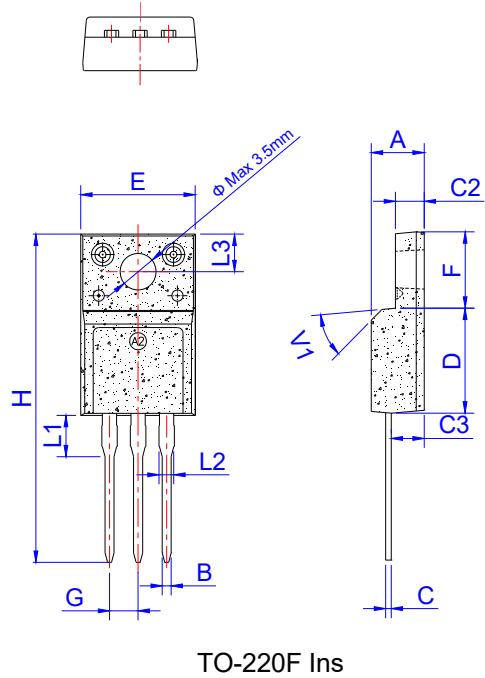


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.70		0.90	0.028		0.035
C	0.45		0.60	0.018		0.024
C2	1.25		1.35	0.049		0.053
C3	2.20		2.60	0.087		0.102
D	8.90		9.90	0.350		0.390
E	9.90		10.3	0.390		0.406
F	6.30		6.90	0.248		0.272
G	2.40		2.70	0.094		0.106
H	28.0		29.8	1.102		1.173
L1	2.70		3.30	0.106		0.130
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116

PACKAGE MECHANICAL DATA



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.61		0.88	0.024		0.035
C	0.46		0.70	0.018		0.028
C2	1.21		1.32	0.048		0.052
C3	2.40		2.72	0.094		0.107
D	8.60		9.70	0.339		0.382
E	9.80		10.4	0.386		0.409
F	6.55		6.95	0.258		0.274
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.75			0.148	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
V1		45°			45°	



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.50		4.90	0.177		0.193
B	0.74	0.80	0.83	0.029	0.031	0.033
C	0.47		0.65	0.019		0.026
C2	2.45		2.75	0.096		0.108
C3	2.60		3.00	0.102		0.118
D	8.80		9.30	0.346		0.366
E	9.80		10.4	0.386		0.410
F	6.40		6.80	0.252		0.268
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.63			0.143	
L2	1.14		1.70	0.045		0.067
L3		3.30			0.130	
V1		45°			45°	

FIG.1 Maximum power dissipation versus RMS on-state current

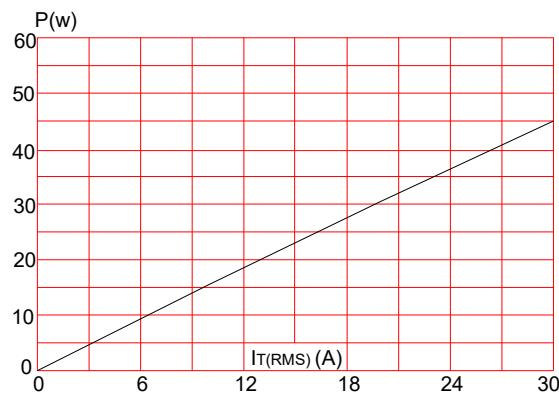


FIG.3: Surge peak on-state current versus number of cycles

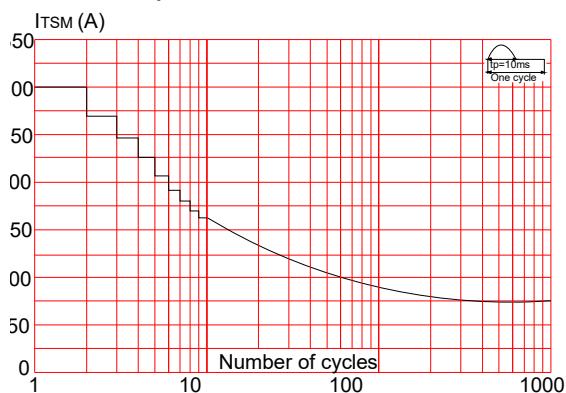


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10\text{ms}$, and corresponding value of I^2t ($dI/dt < 150\text{A}/\mu\text{s}$)

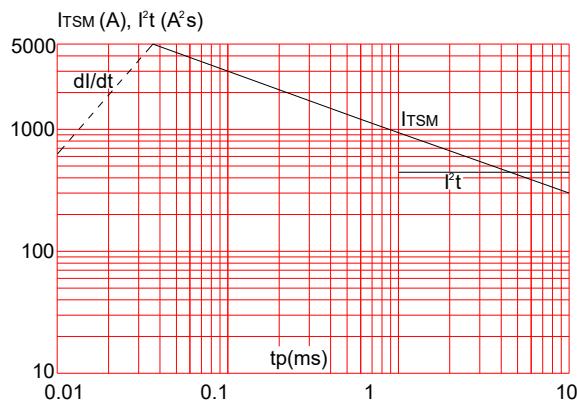


FIG.2: RMS on-state current versus case temperature

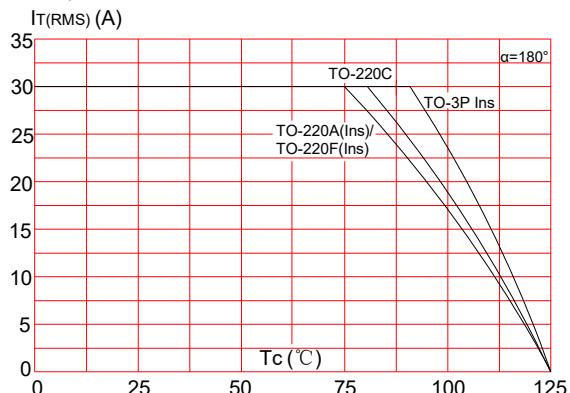


FIG.4: On-state characteristics (maximum values)

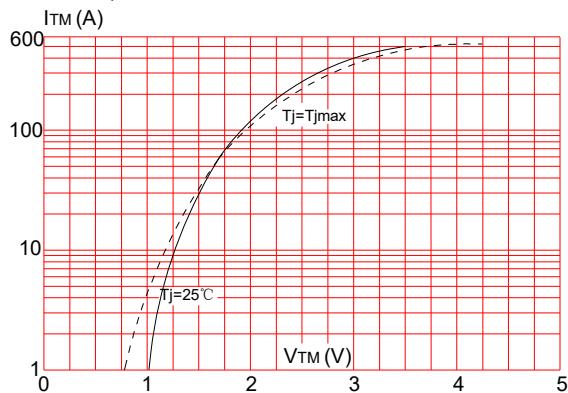
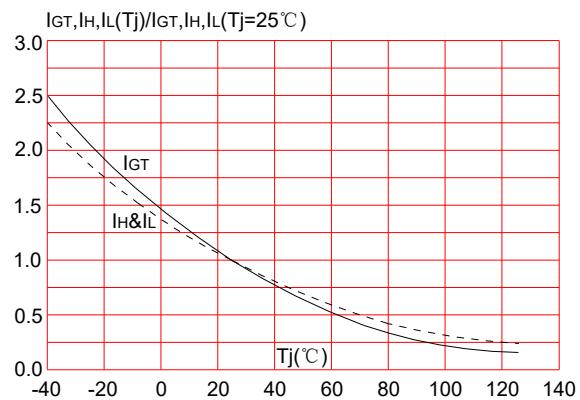


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature



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